HM514105D Series

4194304-word × 1-bit Dynamic RAM

HITACHI

ADE-203-690(Z)
Preliminary
Rev. 0.0
Dec. 10, 1996

Description

The Hitachi HM514105D is a CMOS dynamic RAM organized 4,194,304 word × 1-bit. HM514105D has realized higher density, higher performance and various functions by employing 0.8 µm CMOS process technology and some new CMOS circuit design technologies. The HM514105D offers Extended Data Out (EDO) Page Mode as a high speed access mode. Multiplexed address input permits the HM514105D to be packaged in standard 300-mil 26-pin plastic SOJ and standard 300-mil 26-pin plastic TSOP II.

Features

- Single 5 V (±10%)
- High speed
- Access time: 60 ns/70 ns (max)
- Low power dissipation
  - Active mode: 715 mW/660 mW (max)
  - Standby mode: 11 mW (max)
- EDO page mode capability
- 1024 refresh cycles : 16 ms
- 3 variations of refresh
  - $\overline{\text{RAS}}$-only refresh
  - $\overline{\text{CAS}}$-before-$\overline{\text{RAS}}$ refresh
  - Hidden refresh
- Test function

Preliminary: This document contains information on a new product. Specifications and information contained herein are subject to change without notice.

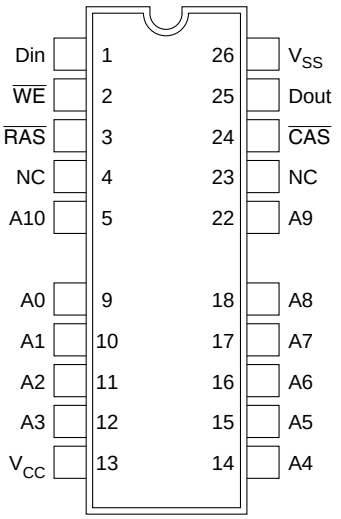
Hitachi semiconductor

Ordering Information

Type No.	Access time	Package
HM514105DS-6	60 ns	300-mil 26-pin plastic SOJ (CP-26/20D)
HM514105DS-7	70 ns	
HM514105DTT-6	60 ns	300-mil 26-pin plastic TSOP II (TTP-26/20D)
HM514105DTT-7	70 ns	

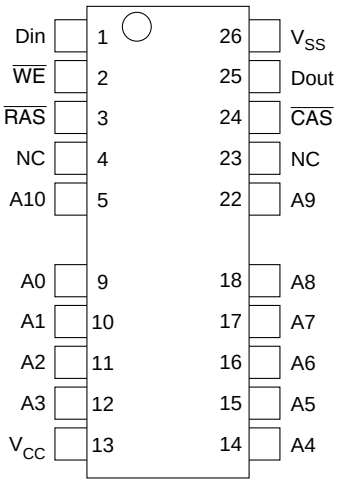
Pin Arrangement

HM514105DS Series



(Top view)

HM514105DTT Series

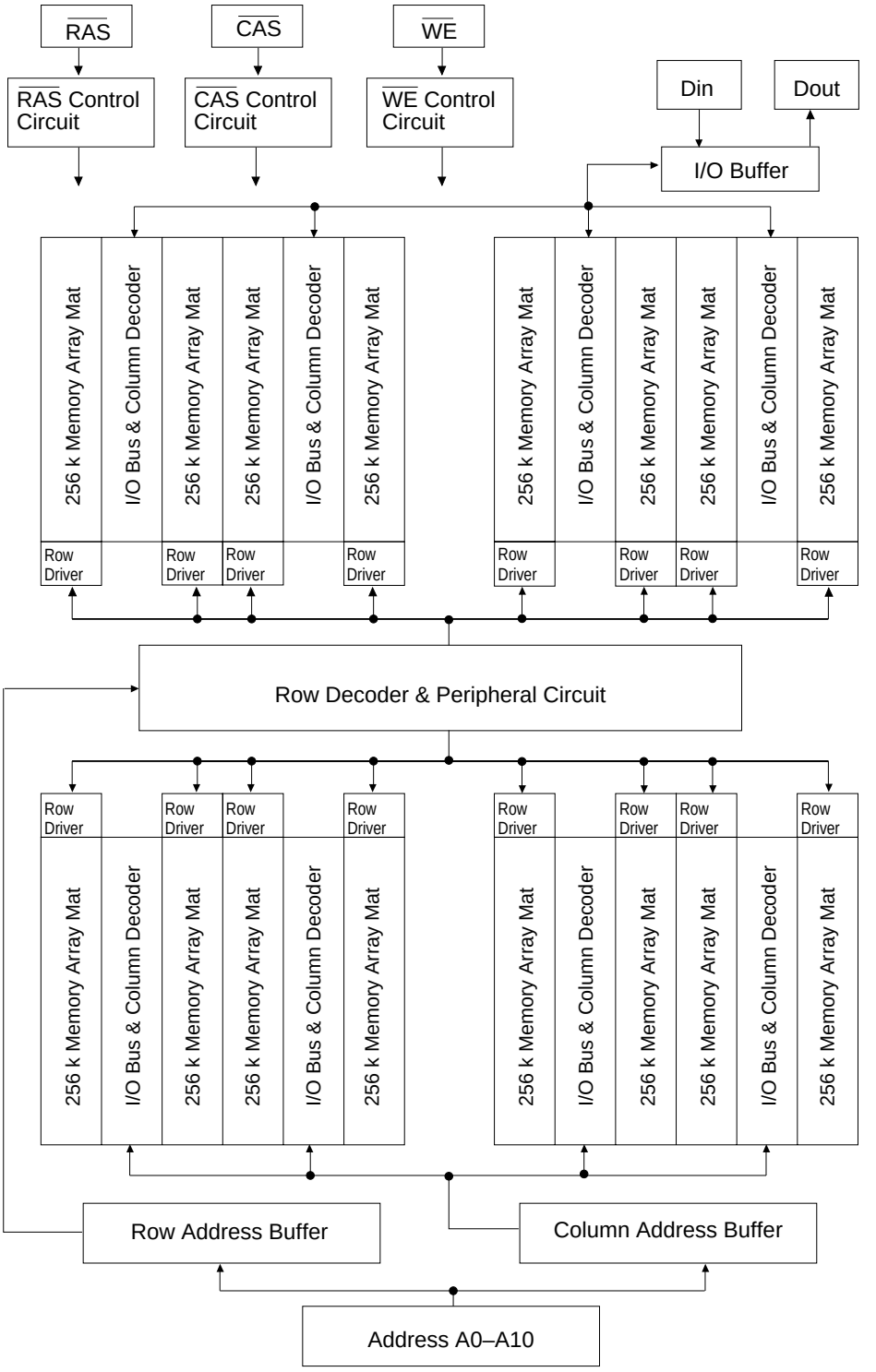


(Top view)

Pin Description

Pin Name	Function
A0 to A10	Address input — Row A0 to A10 Column A0 to A10 Refresh A0 to A9
A0 to A9	Refresh address input
Din	Data input
Dout	Data output
$\overline{RAS}$	Row address strobe
$\overline{CAS}$	Column address strobe
$\overline{WE}$	Read/Write enable
V_{CC}	Power supply
V_{SS}	Ground
NC	No connection

Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Voltage on any pin relative to V_{SS}	V_T	–1.0 to +7.0	V
Supply voltage relative to V_{SS}	V_{CC}	–1.0 to +7.0	V
Short circuit output current	Iout	50	mA
Power dissipation	P_T	1.0	W
Operating temperature	Topr	0 to +70	°C
Storage temperature	Tstg	–55 to +125	°C

Recommended DC Operating Conditions (Ta = 0 to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit	Note
Supply voltage	V_{SS}	0	0	0	V	
	V_{CC}	4.5	5.0	5.5	V	1
Input high voltage	V_{IH}	2.4	—	6.5	V	1
Input low voltage	V_{IL}	–1.0	—	0.8	V	1

Note: 1. All voltage referred to V_{SS}.

DC Characteristics (Ta = 0 to +70°C, V_{CC} = 5 V ± 10%, V_{SS} = 0 V)

		HM514105D					
		-6		-7			
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Unit**	**Test Conditions**
Operating current*[1, 2]	I_{CC1}	—	110	—	100	mA	$\overline{RAS}$, $\overline{CAS}$ cycling t_{RC} = min
Standby current	I_{CC2}	—	2	—	2	mA	TTL interface $\overline{RAS}$, $\overline{CAS}$ = V_{IH} Dout = High-Z
		—	1	—	1	mA	CMOS interface $\overline{RAS}$, $\overline{CAS}$ ≥ V_{CC} – 0.2 V Dout = High-Z
$\overline{RAS}$-only refresh current*[2]	I_{CC3}	—	110	—	100	mA	t_{RC} = min
Standby current*[1]	I_{CC5}	—	5	—	5	mA	$\overline{RAS}$ = V_{IH}, $\overline{CAS}$ = V_{IL} Dout = enable
$\overline{CAS}$-before-$\overline{RAS}$ refresh current	I_{CC6}	—	110	—	100	mA	t_{RC} = min
EDO page mode current*[1, 3]	I_{CC4}	—	130	—	120	mA	t_{HPC} = min
Input leakage current	I_{LI}	–10	10	–10	10	µA	0 V ≤ Vin ≤ 7 V
Output leakage current	I_{LO}	–10	10	–10	10	µA	0 V ≤ Vout ≤ 7 V Dout = disable
Output high voltage	V_{OH}	2.4	V_{CC}	2.4	V_{CC}	V	High Iout = –2 mA
Output low voltage	V_{OL}	0	0.4	0	0.4	V	Low Iout = 2 mA

Notes: 1. I_{CC} depends on output load condition when the device is selected. I_{CC} max is specified at the output open condition.
2. Address can be changed twice or less while $\overline{RAS}$ = V_{IL}.
3. Address can be changed once or less while $\overline{CAS}$ = V_{IH}.

Capacitance (Ta = 25°C, V_{CC} = 5 V ± 10%)

Parameter	**Symbol**	**Typ**	**Max**	**Unit**	**Notes**
Input capacitance (Address, Data-in)	C_{I1}	—	5	pF	1
Input capacitance (Clocks)	C_{I2}	—	7	pF	1
Output capacitance (Data-out)	C_O	—	7	pF	1, 2

Notes: 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.
2. $\overline{RAS}$ and $\overline{CAS}$ = V_{IH} to disable Dout.

AC Characteristics (Ta = 0 to +70°C, V_{CC} = 5 V ± 10%, V_{SS} = 0 V)[*1, *13, *14]

Test Conditions

- Input rise and fall time : 2 ns
- Input level : V_{IL} = 0 V, V_{IH} = 3.0 V
- Input timing reference levels : 0.8 V, 2.4 V
- Output timing reference levels : 0.8 V, 2.0 V
- Output load: 1 TTL gate + C_L (100 pF) (Including scope and jig)

Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

		HM514105D					
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Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Random read or write cycle time	t_{RC}	104	—	124	—	ns	
$\overline{RAS}$ precharge time	t_{RP}	40	—	50	—	ns	
$\overline{RAS}$ pulse width	t_{RAS}	60	10000	70	10000	ns	
$\overline{CAS}$ pulse width	t_{CAS}	10	10000	13	10000	ns	
Row address setup time	t_{ASR}	0	—	0	—	ns	
Row address hold time	t_{RAH}	10	—	10	—	ns	
Column address setup time	t_{ASC}	0	—	0	—	ns	
Column address hold time	t_{CAH}	10	—	13	—	ns	
$\overline{RAS}$ to $\overline{CAS}$ delay time	t_{RCD}	20	45	20	52	ns	8
$\overline{RAS}$ to column address delay time	t_{RAD}	15	30	15	35	ns	9
$\overline{RAS}$ hold time	t_{RSH}	15	—	18	—	ns	
$\overline{CAS}$ hold time	t_{CSH}	48	—	58	—	ns	19
$\overline{CAS}$ to $\overline{RAS}$ precharge time	t_{CRP}	10	—	10	—	ns	
Transition time (rise and fall)	t_T	2	50	2	50	ns	7
Refresh period	t_{REF}	—	16	—	16	ms	

Read Cycle

		HM514105D					
		-6		-7			
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Unit**	**Notes**
Access time from $\overline{RAS}$	t_{RAC}	—	60	—	70	ns	2, 3, 15
Access time from $\overline{CAS}$	t_{CAC}	—	15	—	18	ns	3, 4, 12, 15
Access time from address	t_{AA}	—	30	—	35	ns	3, 5, 12, 17
Read command setup time	t_{RCS}	0	—	0	—	ns	
Read command hold time to $\overline{CAS}$	t_{RCH}	0	—	0	—	ns	16
Read command hold time to $\overline{RAS}$	t_{RRH}	0	—	0	—	ns	16
Column address to $\overline{RAS}$ lead time	t_{RAL}	30	—	35	—	ns	
Column address to $\overline{CAS}$ lead time	t_{CAL}	18	—	23	—	ns	
Output buffer turn-off time	t_{OFF}	—	15	—	15	ns	6, 17
Turn-off to $\overline{RAS}$	t_{OFR}	—	15	—	15	ns	6, 17
Turn-off to $\overline{WE}$	t_{WEZ}	—	15	—	15	ns	6
Output data hold time	t_{OH}	5	—	5	—	ns	
Output data hold time from $\overline{RAS}$	t_{OHR}	5	—	5	—	ns	
Read command hold time from $\overline{RAS}$	t_{RCHR}	60	—	70	—	ns	
Read command hold time from $\overline{CAS}$	t_{RCHC}	15	—	18	—		
Read command hold time from column address	t_{RCHA}	30	—	35	—	ns	

Write Cycle

		HM514105D					
		-6		-7			
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Unit**	**Notes**
Write command setup time	t_{WCS}	0	—	0	—	ns	10
Write command hold time	t_{WCH}	10	—	13	—	ns	
Write command pulse width	t_{WP}	10	—	10	—	ns	
Write command to $\overline{RAS}$ lead time	t_{RWL}	10	—	13	—	ns	
Write command to $\overline{CAS}$ lead time	t_{CWL}	10	—	13	—	ns	
Data-in setup time	t_{DS}	0	—	0	—	ns	
Data-in hold time	t_{DH}	10	—	13	—	ns	

Refresh Cycle

		HM514105D					
		-6		-7			
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Unit**	**Notes**
$\overline{CAS}$ setup time (CBR refresh cycle)	t_{CSR}	10	—	10	—	ns	
$\overline{CAS}$ hold time (CBR refresh cycle)	t_{CHR}	10	—	10	—	ns	
$\overline{RAS}$ precharge to $\overline{CAS}$ hold time	t_{RPC}	10	—	10	—	ns	
$\overline{CAS}$ precharge time in normal mode	t_{CPN}	10	—	13	—	ns	

EDO Page Mode Cycle

		HM514105D					
		-6		-7			
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Unit**	**Notes**
EDO page mode cycle time	t_{HPC}	25	—	30	—	ns	18
EDO page mode $\overline{CAS}$ precharge time	t_{CP}	10	—	13	—	ns	
EDO page mode $\overline{RAS}$ pulse width	t_{RASC}	—	100000	—	100000	ns	11
Access time from $\overline{CAS}$ precharge	t_{ACP}	—	35	—	40	ns	3, 12, 15
$\overline{RAS}$ hold time from $\overline{CAS}$ precharge	t_{RHCP}	35	—	40	—	ns	
Output data hold time from $\overline{CAS}$ low	t_{DOH}	3	—	3	—	ns	
Read command hold time from $\overline{CAS}$ precharge	t_{RCHP}	35	—	40	—	ns	

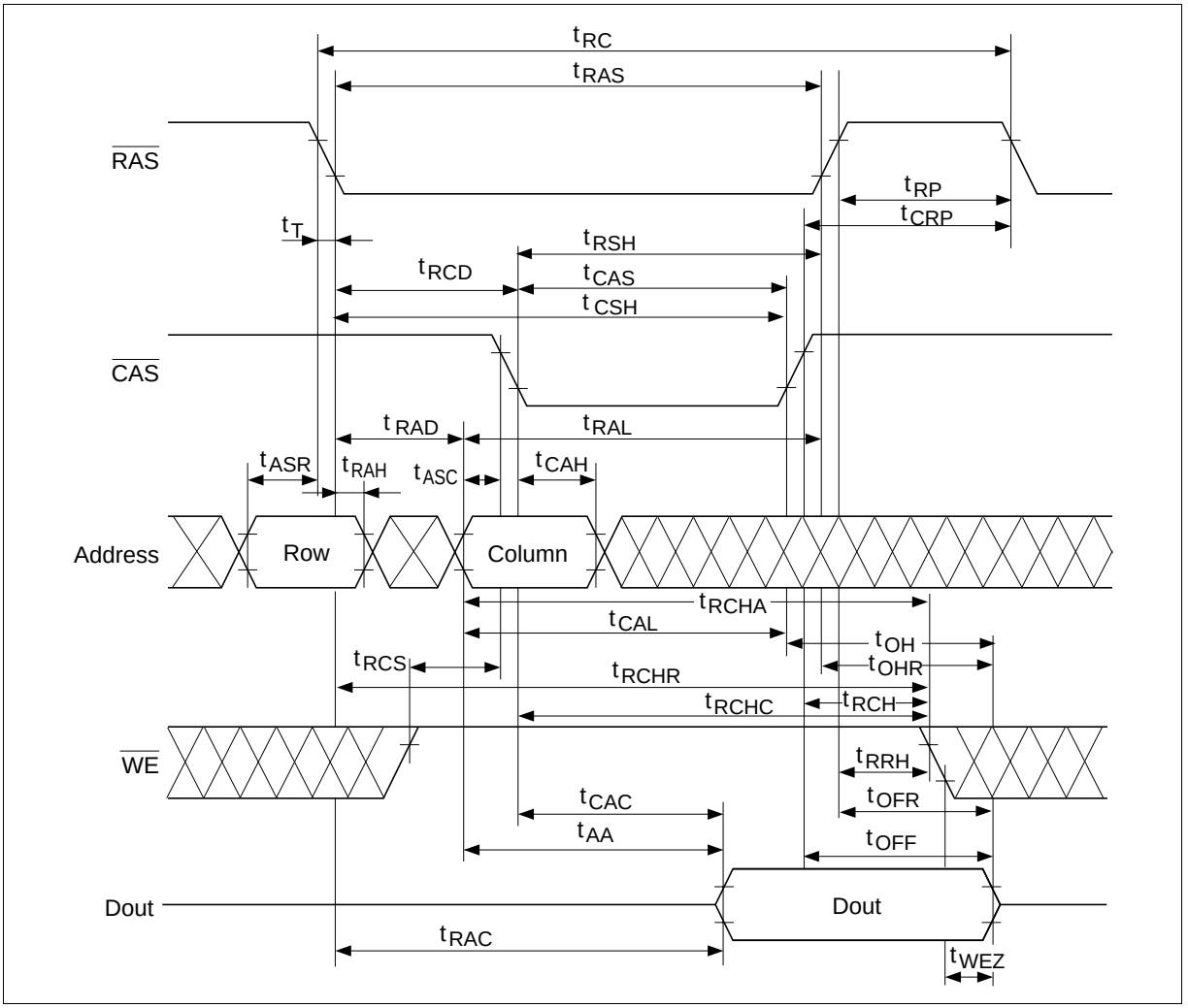
Test Mode Cycle

		HM514105D					
		-6		-7			
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Unit**	**Notes**
Test mode $\overline{WE}$ setup time	t_{WS}	0	—	0	—	ns	
Test mode $\overline{WE}$ hold time	t_{WH}	10	—	10	—	ns	

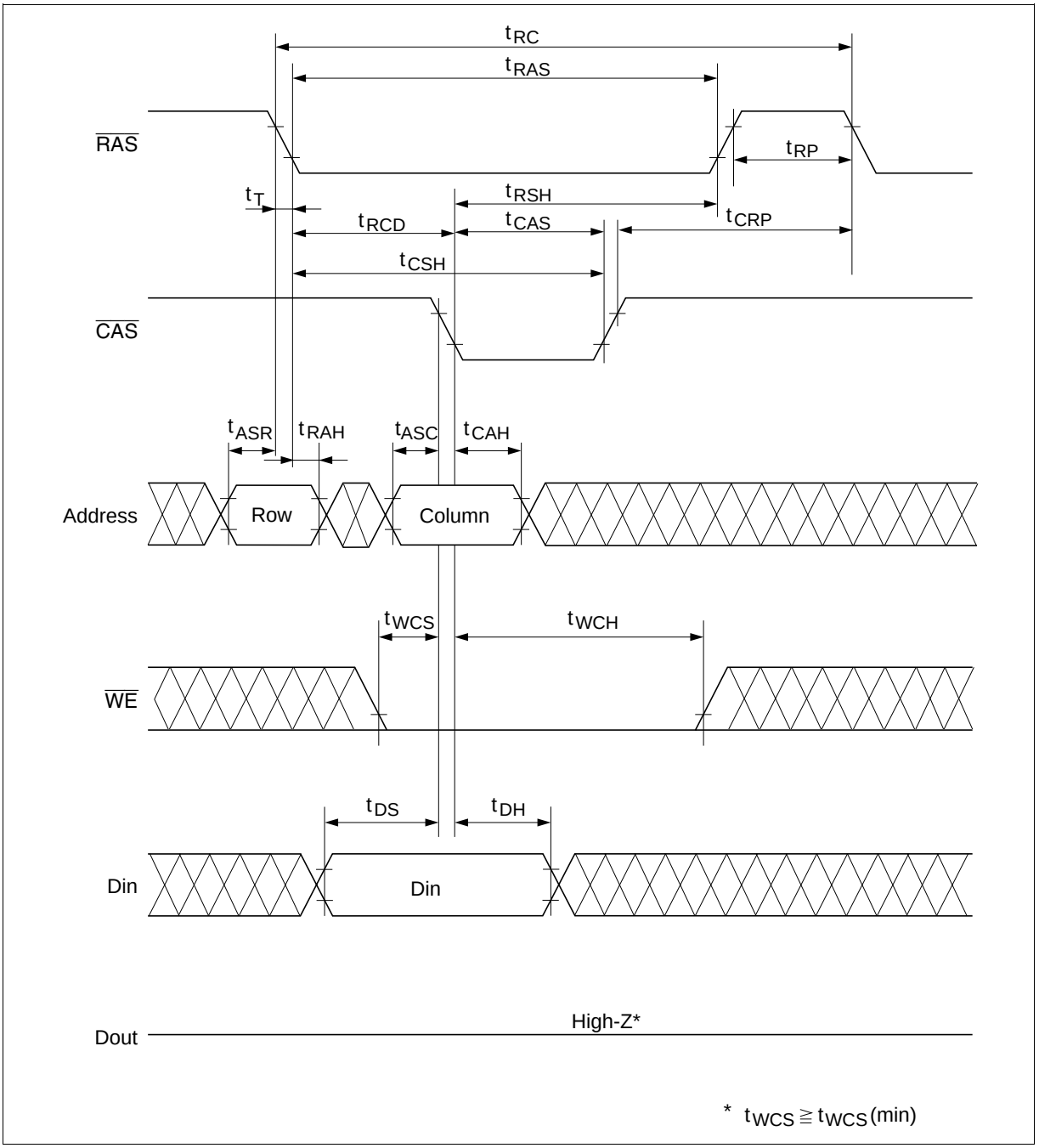
Notes:
1. AC measurements assume t_T = 2 ns.
2. Assumes that $t_{RCD} \leq t_{RCD}$ (max) and $t_{RAD} \leq t_{RAD}$ (max). If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} exceeds the value shown.
3. Measured with a load circuit equivalent to 1 TTL loads and 100 pF.
4. Assumes that $t_{RCD} \geq t_{RCD}$ (max) and $t_{RAD} \leq t_{RAD}$ (max).
5. Assumes that $t_{RCD} \leq t_{RCD}$ (max) and $t_{RAD} \geq t_{RAD}$ (max).
6. t_{OFF} (max), t_{OFR} (max) and t_{WEZ} (max) define the time at which the output achieves the open circuit condition and is not referred to output voltage levels.
7. V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} and V_{IL}.
8. Operation with the t_{RCD} (max) limit insures that t_{RAC} (max) can be met, t_{RCD} (max) is specified as a reference point only, if t_{RCD} is greater than the specified t_{RCD} (max) limit, then access time is controlled exclusively by t_{CAC}.
9. Operation with the t_{RAD} (max) limit insures that t_{RAC} (max) can be met, t_{RAD} (max) is specified as a reference point only, if t_{RAD} is greater than the specified t_{RAD} (max) limit, then access time is controlled exclusively by t_{AA}.
10. if tWCS ≥ tWCS (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle.
11. t_{RASC} defines $\overline{RAS}$ pulse width in EDO page mode cycles.
12. Access time is determined by the longest among t_{AA}, t_{CAC} and t_{ACP}.
13. An initial pause of 100 μs is required after power up followed by a minimum of eight initialization cycles ($\overline{RAS}$-only refresh cycle or $\overline{CAS}$-before-$\overline{RAS}$ refresh cycle). If the internal refresh counter is used, a minimum of eight $\overline{CAS}$-before-$\overline{RAS}$ refresh cycles is required.
14. Test mode operation specified in this data sheet is 8-bit test function controlled by control address bits - - - RA10, CA10 and CA0. This test mode operation can be performed by $\overline{WE}$-and-$\overline{CAS}$-before-$\overline{RAS}$ (WCBR) refresh cycle. Refresh during test mode operation will be performed by normal read cycles or by WCBR refresh cycles. When the state of eight test bits accord each other, the condition of the output data is high level. When the state of test bits do not accord, the condition of the output data is low level. Data output pin is Dout and data input pin is Din. In order to end this test mode operation, perform a $\overline{CAS}$-before-$\overline{RAS}$ refresh cycle or a $\overline{RAS}$-only refresh cycle.
15. In a test mode read cycle, the value of t_{RAC}, t_{AA}, t_{CAC} and t_{ACP} is delayed for 2 ns to 5 ns for the specified value. These parameters should be specified in test mode cycles by adding the above value to the specified value in this data sheet.
16. Either t_{RCH} or t_{RRH} must be satisfied
17. Data output turns off and becomes high impedance from later rising edge of $\overline{RAS}$ and $\overline{CAS}$. Hold time and turn off time are specified by the timing specifications of later rising edge of $\overline{RAS}$ and $\overline{CAS}$ between t_{OHR} and t_{OH}, and between t_{OFF} and t_{OFR}.
18. t_{HPC} (min) can be achieved during a series of EDO page mode early write cycles or EDO page mode read cycles.
19. t_{CSH} (min) can be achieved when $t_{RCD} \leq t_{CSH}$ (min) – t_{CAS} (min).
20. XXX: H or L (H: V_{IH} (min) ≤ V_{IN} ≤ V_{IH} (max), L: V_{IL} (min) ≤ V_{IN} ≤ V_{IL} (max))
    ///////: Invalid Dout

Timing Waveforms[*20]

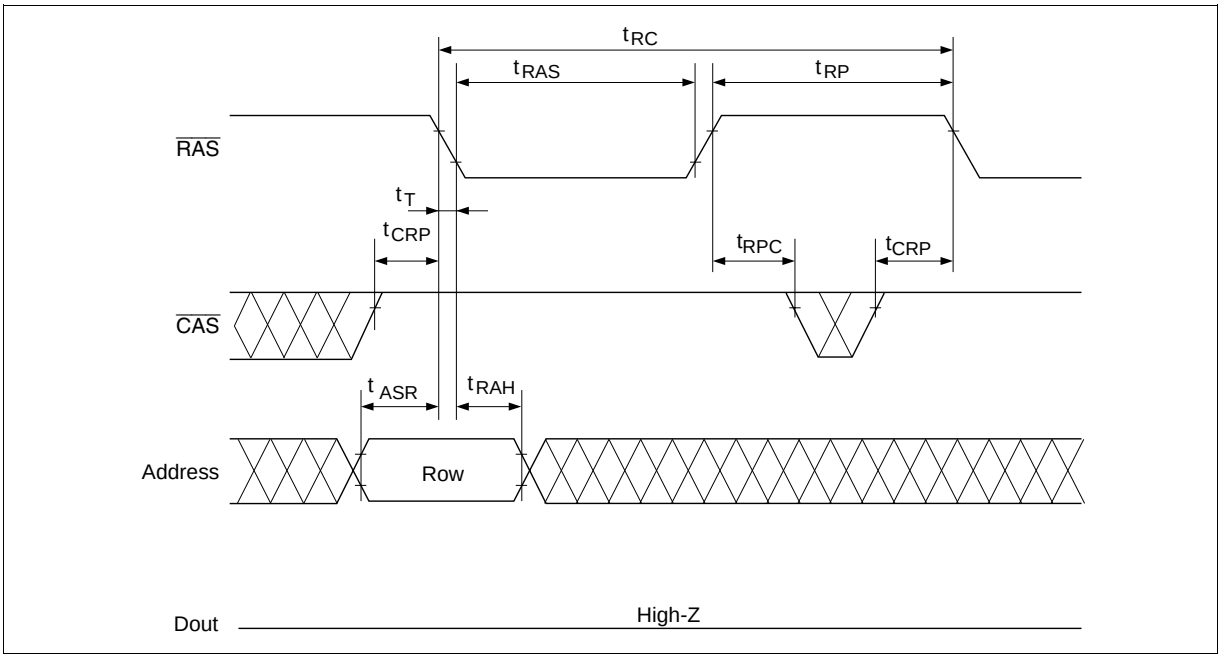
Read Cycle



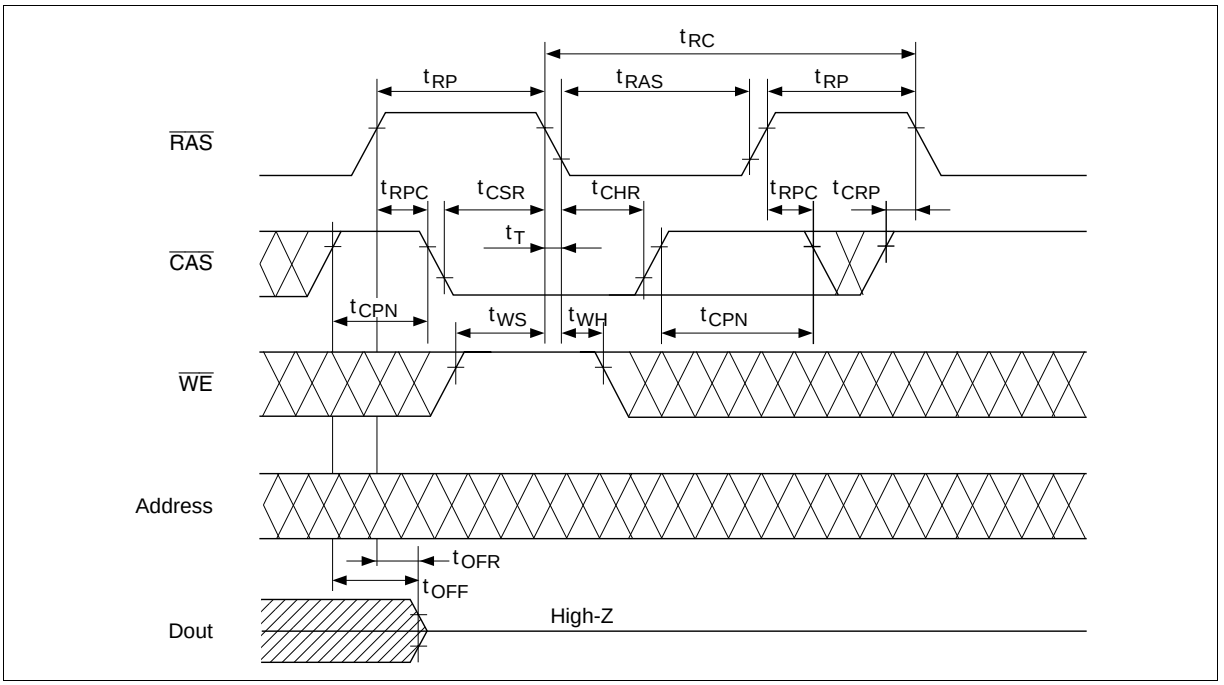
Early Write Cycle



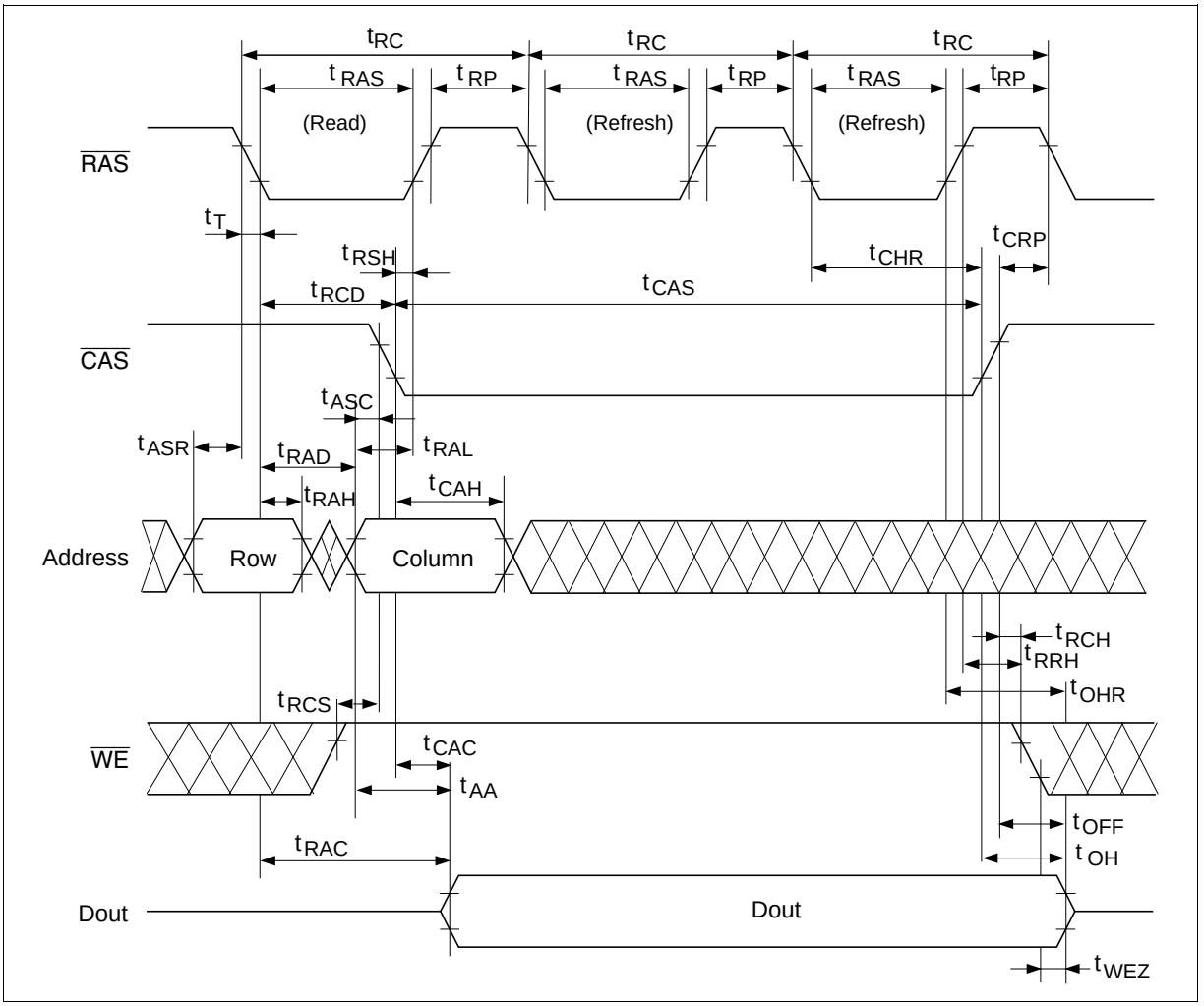
$\overline{\text{RAS}}$-Only Refresh Cycle



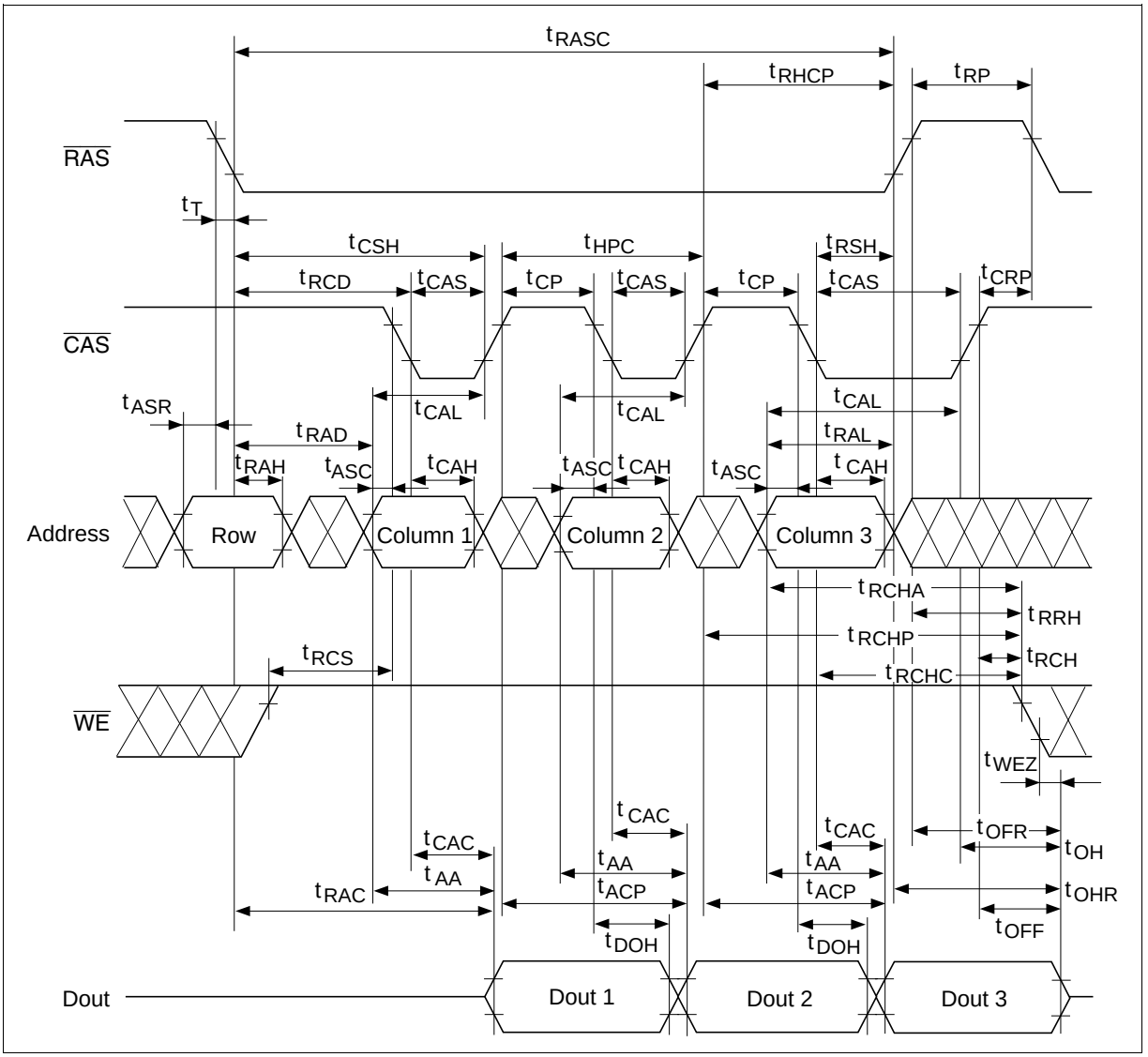
$\overline{\text{CAS}}$-Before-$\overline{\text{RAS}}$ Refresh Cycle



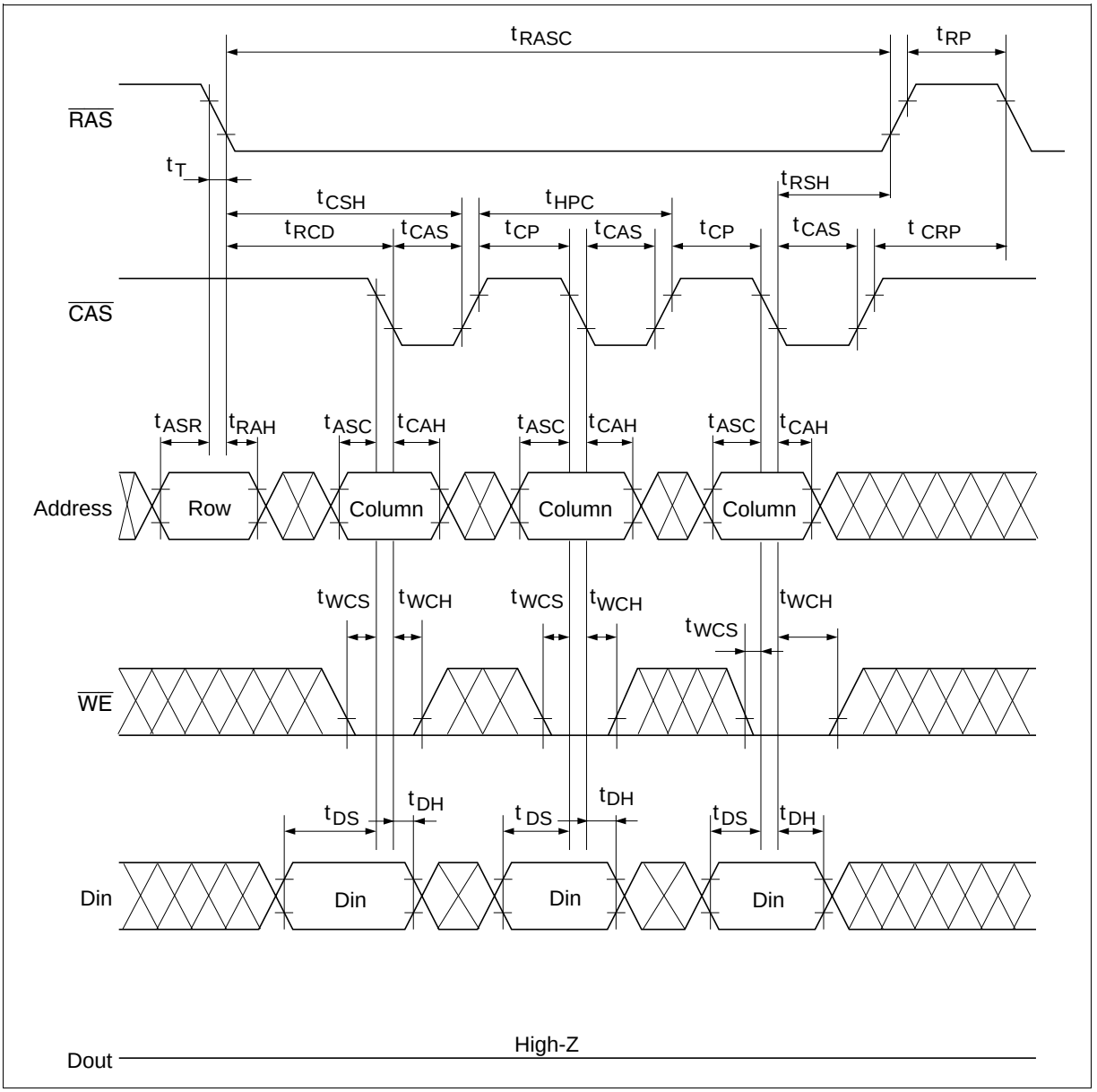
Hidden Refresh Cycle



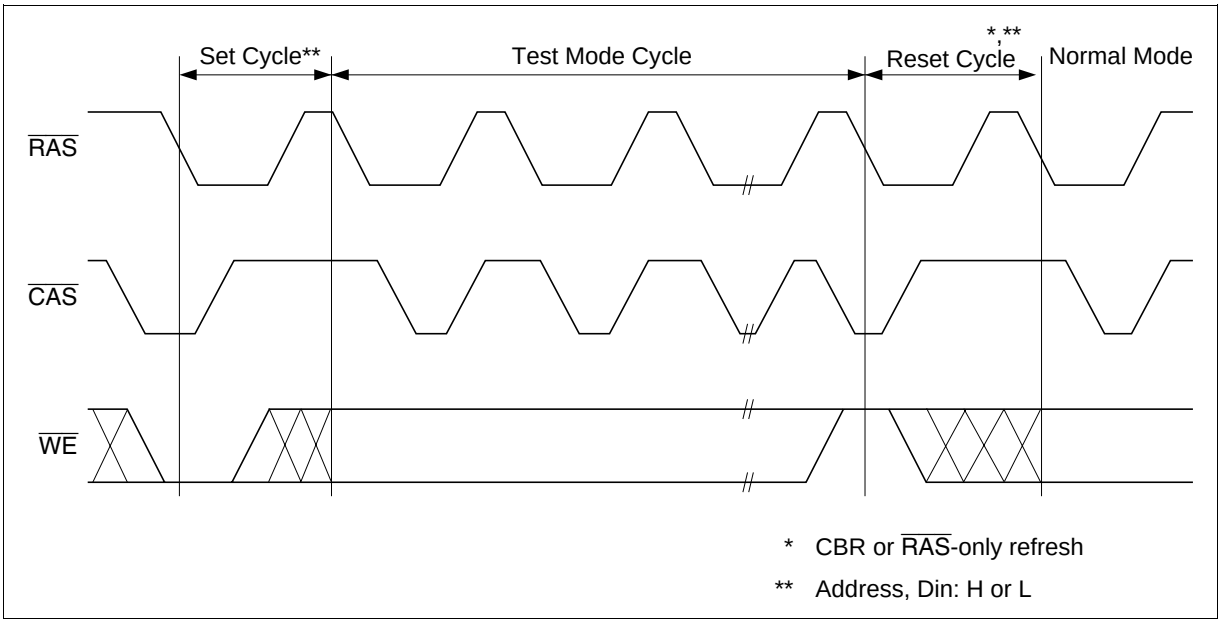
EDO Page Mode Read Cycle (t_{HPC} minimum cycle operation)



EDO Page Mode Early Write Cycle (t_{HPC} minimum cycle operation)

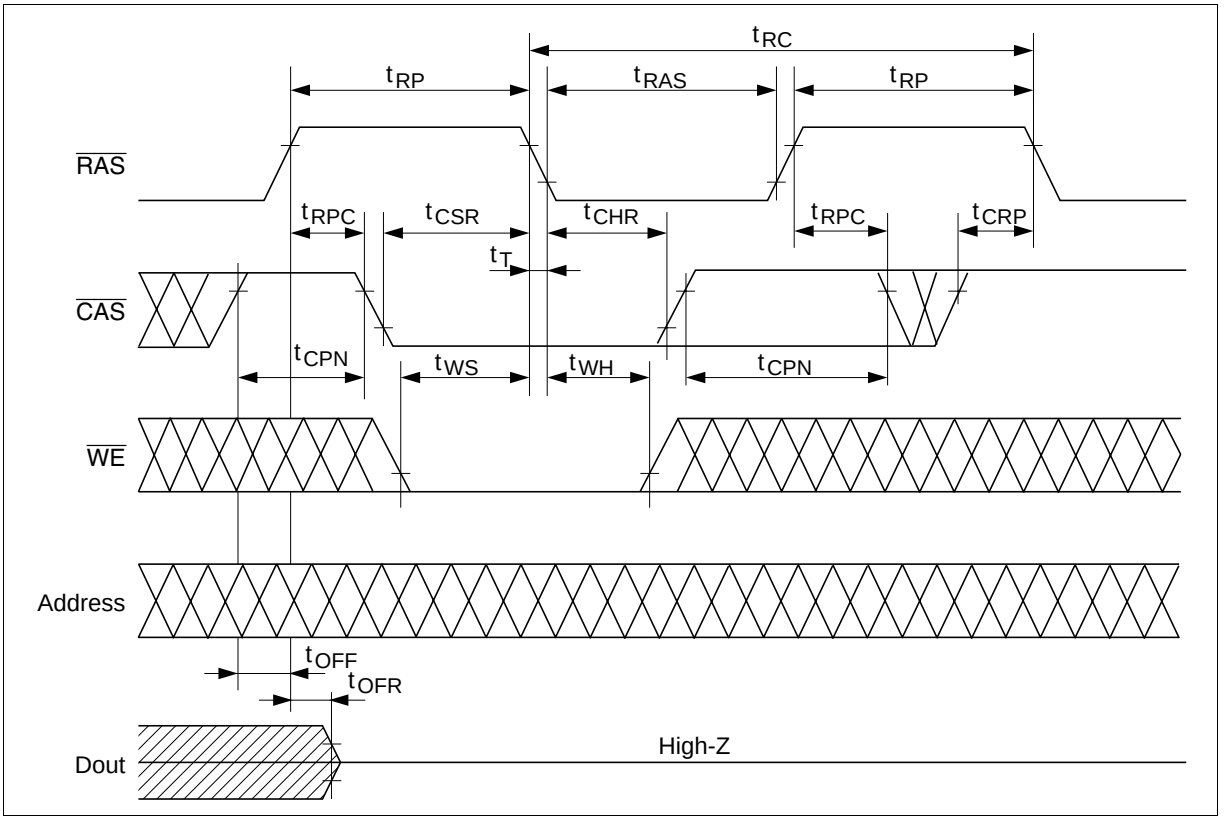


Test Mode Cycle



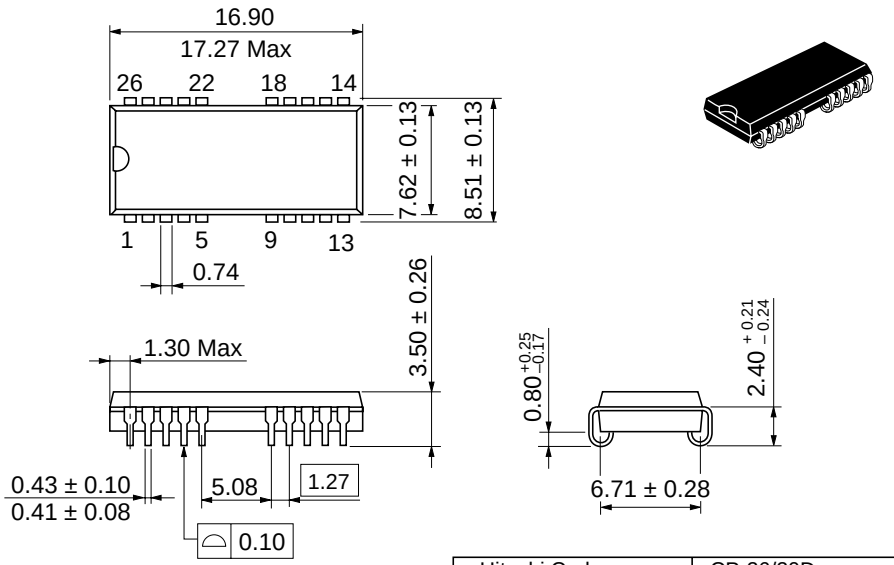
Test Mode Set Cycle

$\overline{WE}$-and-$\overline{CAS}$-Before $\overline{RAS}$-Refresh Cycle



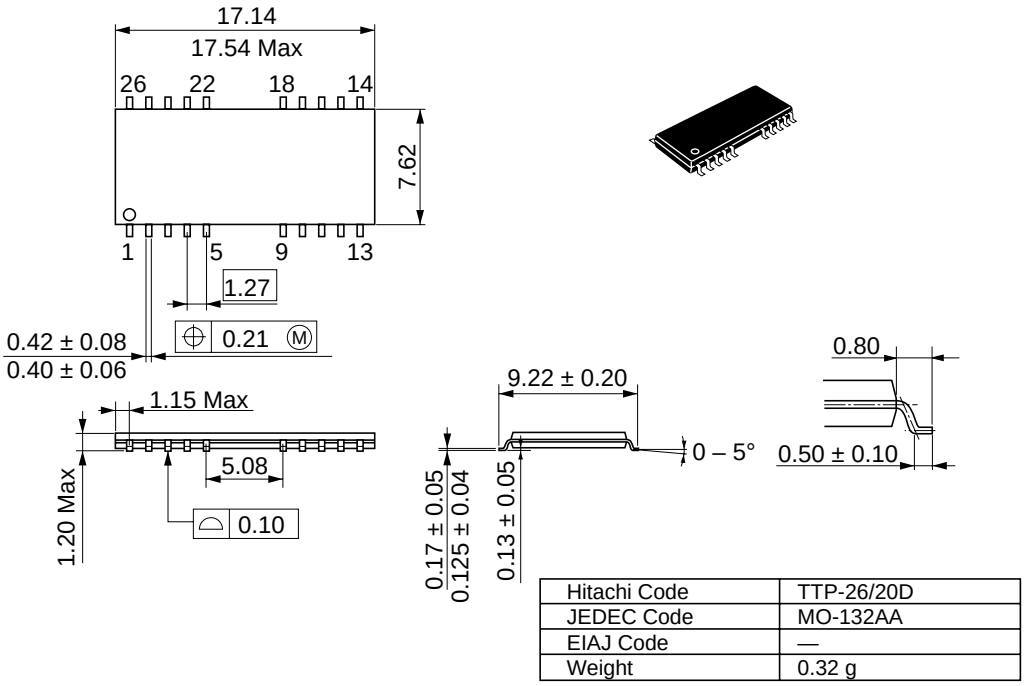
Package Dimensions

HM514105DS Series (CP-26/20D) Unit: mm



Hitachi Code	CP-26/20D
JEDEC Code	MO-077-AA
EIAJ Code	SC-633A
Weight	0.6 g

HM514105DTT Series (TTP-26/20D) Unit: mm



Hitachi Code	TTP-26/20D
JEDEC Code	MO-132AA
EIAJ Code	—
Weight	0.32 g

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Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
0.0	Dec. 10, 1996	Initial issue		